

# SLOVENSKI STANDARD

## SIST EN IEC 60384-21:2019

01-maj-2019

Nadomešča:  
SIST EN 60384-21:2012

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**Fiksni kondenzatorji za uporabo v elektronski opremi - 21. del: Področna specifikacija - Fiksni večplastni kondenzatorji za površinsko namestitev s keramičnim dielektrikom, razred 1 (IEC 60384-21:2019)**

Fixed capacitors for use in electronic equipment - Part 21: Sectional specification - Fixed surface mount multilayer capacitors of ceramic dielectric, Class 1 (IEC 60384-21:2019)

**iTeh STANDARD PREVIEW**

Festkondensatoren zur Verwendung in Geräten der Elektronik - Teil 21: Rahmenspezifikation - Oberflächenmontierbare Vielschichtkeramik-Festkondensatoren, Klasse 1 (IEC 60384-21:2019)

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Condensateurs fixes utilisés dans les équipements électroniques - Partie 21: Spécification intermédiaire: Condensateurs multicouches fixes à diélectriques en céramique pour montage en surface, de classe 1 (IEC 60384-21:2019)

**Ta slovenski standard je istoveten z: EN IEC 60384-21:2019**

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**ICS:**

31.060.10      Fiksni kondenzatorji      Fixed capacitors

**SIST EN IEC 60384-21:2019**      en

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EUROPEAN STANDARD

**EN IEC 60384-21**

NORME EUROPÉENNE

EUROPÄISCHE NORM

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Supersedes EN 60384-21:2012

English Version

**Fixed capacitors for use in electronic equipment - Part 21:  
Sectional specification - Fixed surface mount multilayer  
capacitors of ceramic dielectric, Class 1  
(IEC 60384-21:2019)**

Condensateurs fixes utilisés dans les équipements électroniques - Partie 21: Spécification intermédiaire - Condensateurs multicouches fixes à diélectriques en céramique pour montage en surface, de classe 1 (IEC 60384-21:2019)

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Europäisches Komitee für Elektrotechnische Normung

**CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels**

**EN IEC 60384-21:2019 (E)****European foreword**

The text of document 40/2639/FDIS, future edition 3 of IEC 60384-21, prepared by IEC/TC 40 "Capacitors and resistors for electronic equipment" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 60384-21:2019.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2019-12-05
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2022-03-05

This document supersedes EN 60384-21:2012.

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The text of the International Standard IEC 60384-21:2019 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following note has to be added for the standard indicated:

IEC 60384-14      NOTE      Harmonized as EN 60384-14

## Annex ZA (normative)

### Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: [www.cenelec.eu](http://www.cenelec.eu).

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60063	-	Preferred number series for resistors and capacitors	EN 60063	-
IEC 60068-1	2013	Environmental testing - Part 1: General and guidance	EN 60068-1	2014
IEC 60068-2-58	2015	Environmental testing - Part 2-58: Tests - Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)	EN 60068-2-58	2015
+ A1	2017		+ A1	2018
IEC 60384-1	2016	Fixed capacitors for use in electronic equipment - Part 1: Generic specification	EN 60384-1	2016
IEC 61193-2	2007	Quality assessment systems - Part 2: Selection and use of sampling plans for inspection of electronic components and packages	EN 61193-2	2007
ISO 3	1973	Preferred numbers - Series of preferred numbers	-	-

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IEC 60384-21

Edition 3.0 2019-01

# INTERNATIONAL STANDARD

## NORME INTERNATIONALE

**Fixed capacitors for use in electronic equipment –  
Part 21: Sectional specification – Fixed surface mount multilayer capacitors  
of ceramic dielectric, Class 1**

**Condensateurs fixes utilisés dans les équipements électroniques –  
Partie 21: Spécification intermédiaire – Condensateurs multicouches fixes à  
diélectriques en céramique pour montage en surface, de Classe 1**

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ELECTROTECHNICAL  
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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

## FIXED CAPACITORS FOR USE IN ELECTRONIC EQUIPMENT –

**Part 21: Sectional specification –  
Fixed surface mount multilayer capacitors  
of ceramic dielectric, Class 1**

## FOREWORD

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International Standard IEC 60384-21 has been prepared by IEC technical committee 40: Capacitors and resistors for electronic equipment.

This third edition cancels and replaces the second edition published in 2011. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) revision of the structure in accordance with ISO/IEC Directives, Part 2:2016 to the extent practicable, and for harmonizing with IEC 60384-22;
- b) deletion of the description on the permissible reactive power in 6.2.2 because it is not appropriate for the purposes of this document;

c) the dimensions of 0201M in Annex A have been added.

The text of this International Standard is based on the following documents:

FDIS	Report on voting
40/2639/FDIS	40/2651/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 60384 series, published under the general title *Fixed capacitors for use in electronic equipment*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

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